

# 2008 HIGHER SCHOOL CERTIFICATE EXAMINATION

# Industrial Technology Electronics Industries

#### **General Instructions**

- Reading time 5 minutes
- Working time  $1\frac{1}{2}$  hours
- Write using black or blue pen
- Draw diagrams using pencil
- Board-approved calculators may be used
- Write your Centre Number and Student Number at the top of this page and pages 5, 9, 13 and 17

#### Total marks – 100

Section I Pages 2–12

#### 60 marks

- Attempt Questions 1–3
- Allow about 55 minutes for this section

Section II Pages 13–20

#### 40 marks

- Attempt Questions 4–5
- Allow about 35 minutes for this section

### **Section I**

60 marks Attempt Questions 1–3 Allow about 55 minutes for this section

Answer the questions in the spaces provided.

Marks

Use the following information to answer Questions 1 and 2.

IND-TECH is a company in the electronics industry seeking to increase its market share by establishing an overseas facility.

### Question 1 (20 marks)

(a)	Identify TWO sources of finance that IND-TECH might use to fund the	2
(u)	establishment of the overseas facility.	_
(b)	How can IND-TECH locate and evaluate emerging technology?	3

Question 1 continues on page 3

Question 1 continues on page 4

(e)	IND-TECH has identified quality control as a potential area of concern when overseas operations commence.	7
	Evaluate strategies that can be implemented to establish and monitor the required standard of quality.	

# **End of Question 1**

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Que	estion 2 (20 marks)								M	arks		
(a)	Outline TWO issues that may be included in a (EIS).	n <i>Env</i>	ironn	nento	al Im	pact	State	men	t	2		
		•••••			•••••							
(1-)	W/L	4:_	1 1			1 6-				2		
(b)	Why is it important to have an effective occupolicy in place when the new facility is established	-		ieaitr	i anc	i sare	ну (С	JHS,	)	3		
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Question 2 continues on page 6

191a – 5 –

**Question 2 continues on page 7** 

(e)	IND-TECH proposes to relocate some employees to the overseas facility to	7
	assist in setting it up and training staff.	
	Analyse this proposal from the perspective of both IND-TECH and the employees who would be relocating.	

**End of Question 2** 

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Section I (continued)	Student Number
Question 3 (20 marks)	Marks
(a) Name TWO software applications	s that can be used to graph production costs. 2

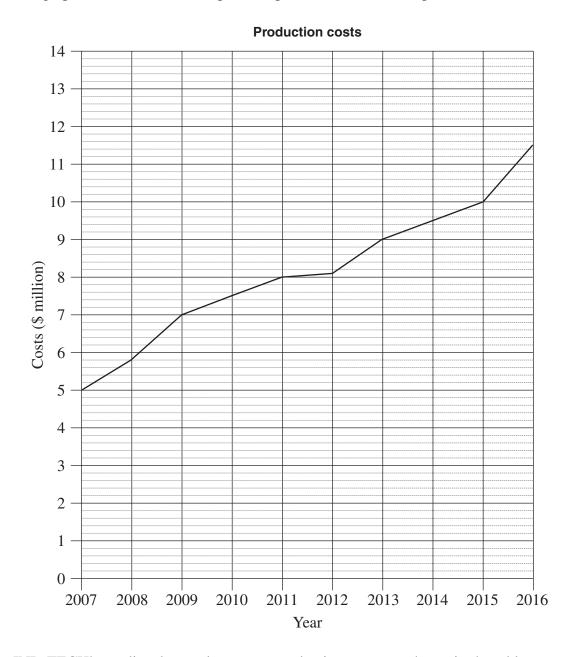
Question 3 continues on page 10

191b - 9 -

## Question 3 (continued)

Use the following information to answer part (b).

The graph shows IND-TECH's past and predicted annual local production costs.



IND-TECH's predicted annual overseas production costs are shown in the table.

Year	2009	2010	2011	2012	2013	2014	2015	2016
Production costs (\$ million)	10.0	8.5	8.0	6.0	6.5	7.0	7.5	7.8

Question 3 continues on page 11

Questi	on 3 (	(continued)	Marks
(b)	(i)	Graph the predicted annual overseas production costs on the grid on the previous page.	2
	(ii)	When should overseas production costs match local production costs?	1
	(iii)	Describe the trends in the graphs for local and overseas production costs.	4
	(iv)	Outline factors IND-TECH would need to consider when estimating predicted production costs.	4

Question 3 continues on page 12

(c)	IND-TECH intends to produce an operations manual for the overseas facility using a combination of text, graphics, photographs and charts.	7
	Explain how the different forms of presenting the information would support the purpose of the operations manual.	

# **End of Question 3**

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Atte	narks empt Questions 4–5 w about 35 minutes for this section						50	uccii	t IVui	noci
Ansv	wer the questions in the spaces provided.									
Que	estion 4 (20 marks)								M	arks
(a)	Calculate the resistance in a 24 volt circuit w	ith a c	curre	nt of	1.2 a	amp.				2
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(b)	Describe TWO different 12 volt power source	es.								3
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**Question 4 continues on page 14** 

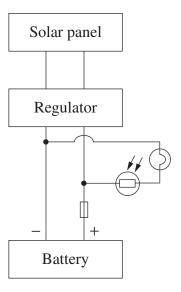
192 - 13 -

Ques	tion 4 (continued)	Marks
(c)	How are inductive coils used in transformers to 'step up' or 'step down' a voltage?	4
(d)	Explain, using a diagram, how a variable capacitor works. In your explanation, include a practical application for its use.	4

**Question 4 continues on page 15** 

7

(e) A schematic diagram representing a solar powered light is shown.



Explain the operation of the circuit. In your answer, refer to the function of each component.

**Question 4 continues on page 16** 

Quest	ion 4 (continued)

**End of Question 4** 

# Industrial Technology Electronics Industries

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Section II (continued)

Student Number

#### Marks

# Question 5 (20 marks)



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Question 5 continues on page 18

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Que	stion 5 (continued)	
(b)	Describe, with the aid of sketches, the difference between using a voltmeter and an ammeter to test a circuit.	3

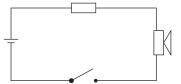
Marks

**Question 5 continues on page 19** 

Ques	stion 5 (continued)	Marks
(c)	Compare TWO methods of PCB manufacture.	4
(d)	Explain the use and application of heat shrink in electronics.	4

Question 5 continues on page 20

(e) The circuit diagram shown has been used to construct a buzzer. On completion the buzzer was found to be inoperative.



Describe a fault finding process that could be used to diagnose the cause of the problem. In your answer, refer to the use of test equipment for each component.

End of paper